TEB 2 5 MINS. A. PRADEM A PROJECT



Applicants: Dulai, et al. Serial No.: 09/921,612

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Commissioner for Patents

Washington, D.C. 20231

Examiner: J. Duverne

Art Group: 2839

Our File No.: 00100.01.0051 Docket No.: 0100.010051T

Title: HIGH DENSITY INTERCONNECTION DEVICE

## **CERTIFICATE OF MAILING**

I hereby certify that this Amendment and Response is being deposited with the United States Postal Service by First Class Mail, postage pre-paid, on this date February 20, 2003, in an envelope addressed to:

Box Non-Fee Amendment Commissioner for Patents Washington, D.C. 20231

Michael J. Turgeon, #39404

February 20, 2003

## **AMENDMENT AND RESPONSE UNDER 37 C.F.R. §1.111**

Dear Sir:

This Response is being submitted in response to the Office Action dated November 20, 2002 relating to the above-identified application. Reexamination and reconsideration of said application are respectfully requested.

## In the Claims:

Please add new claims 29-34 to read as follows:

29. (New) A high density audio/video input/output interconnection device comprising:

a high density connector block that includes a plurality of jacks disposed on an outer surface of the high density connector block including, a S-video input jack, a S-video output jack, a video output jack, a video output jack, at least one audio output jack and at least one audio input jack;

a high density connector commonly interconnected to the plurality of jacks; and,

a plug for stereo audio output interconnected to the high density connector for interface with a computer.

30. (New) The connector as recited in claim 29, wherein the plurality of jacks further include a digital video input/output jack.

A' Subject